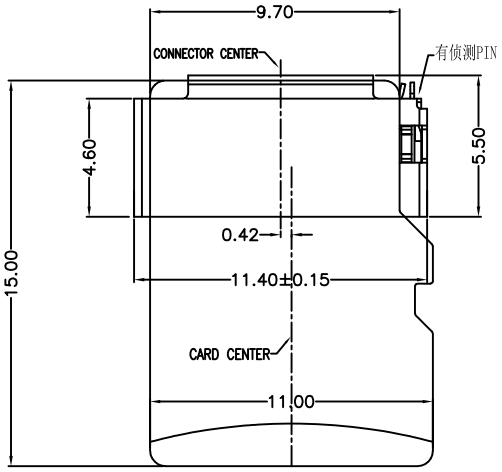
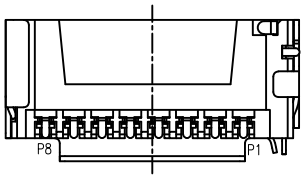
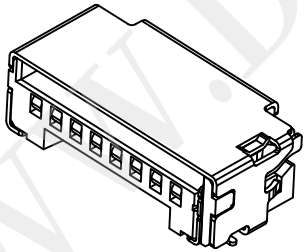
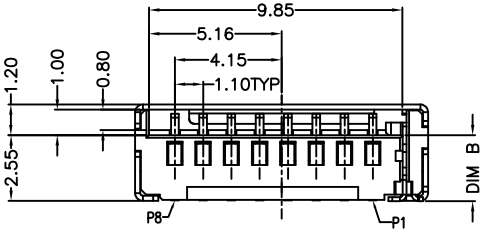
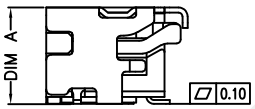


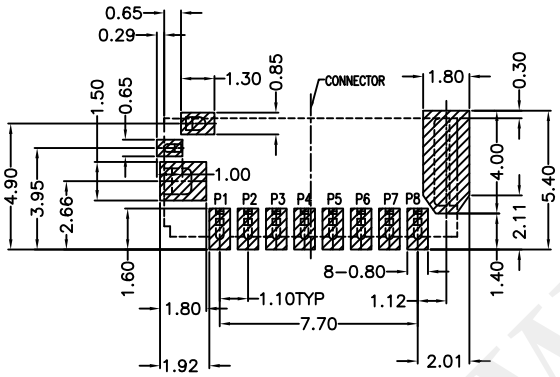




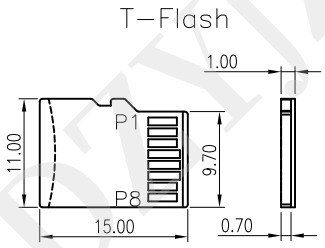




序号	DIM A	DIM B	料 号
1	3.75	2.61	HYC198-TF08-375
2	3.35	2.21	HYC198-TF08-335
3	3.0	1.91	HYC198-TF08-300
4	2.85	1.70	HYC198-TF08-285
5	2.65	1.50	HYC198-TF08-265



RECOMMENED P.C.BOARD LAYOUT
GENERAL TOLERANCE ±0.05



pin number	pin name
pin 1	DAT2
pin 2	CD/DAT3
pin 3	CMD
pin 4	VDD
pin 5	CLK
pin 6	VSS
pin 7	DAT0
pin 8	DAT1

NOTES:
1. MATERIAL:
   1.1 Housing:High Temperature Thermoplastic UL94V-0; Color Black.
   1.2 Terminal:Copper Alloy.
   1.3 Shell:Stainless Steel.
2. Electrical:
   2.1 Rated current:0.5A
   2.2 Rated voltage:30V
   2.3 Contact Resistance:50mΩ MAX
   2.4 Insulation Resistance:1000MΩ MIN
   2.5 Dielectric withstanding voltage: 500V RMS.
   2.6 Solder ability:235±5℃, 5±0.5s.
   2.8 Operating condition:Temperature-25℃~+85℃; Humidity 80% R.H MAX
3. Environment:
   3.1 Operating condition:Temperature-25℃~+85℃; Humidity 80% R.H MAX
4. Mechanical:
   4.1 MATE AND UNMATE FORCE:MATE FORCE:4.5kg MAX UNMATE FORCE:0.5kg MINDurability:1500cycles MIN.
5. FINISH:
   5.1 TERMINAL:GOLD Plated Over NICKEL Contact area,TIN ONSOLDER TAIL AREA& TINPlated ALL Over NICKEL.
   5.2 Shell: SPCC WITH NICKEL&GOLD Plated

深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30, X.XX ±0.25, X.XXX ±0.15, X.° ±2°, X.X° ±0.5°	DRAWED BY: 陈一鸣	DATE: 2014-02-23	PART NAME: TF 短体带检测PIN
	CHECKED BY: 马跃	DATE: 2014-02-23	PART NO.: HYC198-TF08-XXX
UNIT: mm [inch]	APPROVED BY: 邱敏	DATE: 2014-02-23	MOLD NO.:
SCALE:1:1 SIZE: A4			DRAW NO.: HYC-2611021148
			SHEET NO.: 1 OF 1

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